

IDS - 10/23/2006


Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number.

**INFORMATION DISCLOSURE  
STATEMENT BY APPLICANT**

( Not for submission under 37 CFR 1.99)

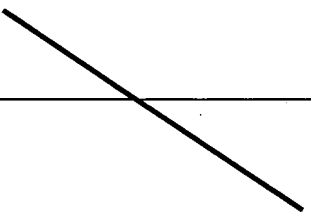
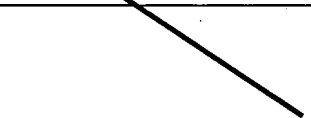
Application Number	10540978
Filing Date	2005-06-27
First Named Inventor	YOSHIKATSU ICHIMURA
Art Unit	2852
Examiner Name	B. Ready
Attorney Docket Number	03500.017987.

**U.S. PATENTS**[Remove](#)

Examiner Initial*	Cite No	Patent Number	Kind Code <sup>1</sup>	Issue Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear
BPR	1	6177800		2001-01-23	Kubby, et al.	

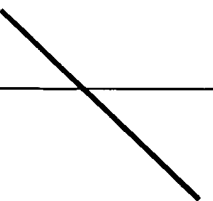

If you wish to add additional U.S. Patent citation information please click the Add button.

[Add](#)**U.S. PATENT APPLICATION PUBLICATIONS**[Remove](#)

Examiner Initial*	Cite No	Publication Number	Kind Code <sup>1</sup>	Publication Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear
BPR	1	20030057977		2003-03-27	Werner, Jr., et al.	
BPR	2	20060171728		2006-08-03	Ichimura, et al	

If you wish to add additional U.S. Published Application citation information please click the Add button.

[Add](#)**FOREIGN PATENT DOCUMENTS**[Remove](#)

Examiner Initial*	Cite No	Foreign Document Number <sup>3</sup>	Country Code <sup>2</sup>	Kind Code <sup>4</sup>	Publication Date	Name of Patentee or Applicant of cited Document	Pages, Columns, Lines where Relevant Passages or Relevant Figures Appear	T <sup>5</sup>
BPR	1	10044887	DE		2001-05-17	Buschnakowski		<input type="checkbox"/>
BPR	2	2715831	DE		1978-10-19	Elwood, et al.		<input type="checkbox"/>

# **INFORMATION DISCLOSURE STATEMENT BY APPLICANT**

( Not for submission under 37 CFR 1.99)

Application Number	10540978
Filing Date	2005-06-27
First Named Inventor	YOSHIKATSU ICHIMURA
Art Unit	2852
Examiner Name	B. Ready
Attorney Docket Number	03500.017987.

BPR	3	1003044	EP		2000-05-24	Kubby, et al.		<input type="checkbox"/>
BPR	4	4-25764	JP		1992-01-29	Yuji		<input type="checkbox"/>
BPR	5	6-196721	JP		1994-07-15	Yukihiro, et al.		<input type="checkbox"/>
BPR	6	6-196722	JP		1994-07-15	Toshimasa, et al.		<input type="checkbox"/>
BPR	7	2004088333	WO		2004-10-14	Ichimura, et al.		<input type="checkbox"/>
BPR	8	2004088335	WO		2004-10-14	Yasuda, et al.		<input type="checkbox"/>

If you wish to add additional Foreign Patent Document citation information please click the Add button

Add

## **NON-PATENT LITERATURE DOCUMENTS**

Remove

Examiner Initials*	Cite No	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc), date, pages(s), volume-issue number(s), publisher, city and/or country where published.	T5
BPR	1	C.H. Hsu, et al., "Micromechanical Electrostatic Voltmeter", San Francisco, June 24-27, 1991, Proceedings of the International Conference on Solid State Sensors and Actuators, New York, IEEE, US, Vol. Conf. 6, 24 June 1991, pgs. 659-662.	<input type="checkbox"/>
BPR	2	P. S. Riehl, "Microsystems for Electrostatic Sensing", Dissertation, November 2002, pgs. 1-8, 32-40 and 79-84, available at <a href="http://www-bsac.eecs.berkeley.edu/publications/search/zoom.php?urltimestamp=1040564878">http://www-bsac.eecs.berkeley.edu/publications/search/zoom.php?urltimestamp=1040564878</a>	<input type="checkbox"/>

If you wish to add additional non-patent literature document citation information please click the Add button

Add

**INFORMATION DISCLOSURE  
STATEMENT BY APPLICANT****( Not for submission under 37 CFR 1.99)**

Application Number	10540978
Filing Date	2005-06-27
First Named Inventor	YOSHIKATSU ICHIMURA
Art Unit	2852
Examiner Name	B. Ready
Attorney Docket Number	03500.017987.

**EXAMINER SIGNATURE**

Examiner Signature	/Bryan Ready/	Date Considered	11/13/2006
--------------------	---------------	-----------------	------------

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through a citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

<sup>1</sup> See Kind Codes of USPTO Patent Documents at [www.USPTO.GOV](http://www.USPTO.GOV) or MPEP 901.04. <sup>2</sup> Enter office that issued the document, by the two-letter code (WIPO Standard ST.3). <sup>3</sup> For Japanese patent documents, the indication of the year of the reign of the Emperor must precede the serial number of the patent document. <sup>4</sup> Kind of document by the appropriate symbols as indicated on the document under WIPO Standard ST.16 if possible. <sup>5</sup> Applicant is to place a check mark here if English language translation is attached.